



"Quasicontinuum analysis of dislocation-coherent twin boundary interaction to provide local rules to discrete dislocation dynamics"

Tran, H.-S ; Tummalah, Hareesh ; Duchêne, L ; Pardoen, Thomas ; Fivel, Marc ; Habraken, A.-M.

ABSTRACT

The interaction of a pure screw dislocation with a Coherent Twin Boundary $\Sigma 3$ in copper was studied using the Quasicontinuum method. Coherent Twin Boundary behaves as a strong barrier to dislocation glide and prohibits slip transmission across the boundary. Dislocation pileup modifies the stress field at its intersection with the Grain Boundary (GB). A methodology to estimate the strength of the barrier for a dislocation to slip across CTB is proposed. A screw dislocation approaching the boundary from one side either propagates into the adjacent twin grain by cutting through the twin boundary or is stopped and increases the dislocation pileup amplitude at the GB. Quantitative estimation of the critical stress for transmission was performed using the virial stress computed by Quasicontinuum method. The transmission mechanism and critical stress are in line with the literature. Such information can be used as input for dislocation dynamic simulations for a better modeling of grain boun...

CITE THIS VERSION

Tran, H.-S ; Tummalah, Hareesh ; Duchêne, L ; Pardoen, Thomas ; Fivel, Marc ; et. al. *Quasicontinuum analysis of dislocation-coherent twin boundary interaction to provide local rules to discrete dislocation dynamics*. 20th International ESAFORM Conference on Material Forming (Dublin, Ireland, du 26/04/2017 au 28/04/2017). In: *AIP Conference Proceedings*, Vol. 1896, no.1 (2017) <http://hdl.handle.net/2078.1/214479>
-- DOI : 10.1063/1.5008190

Le dépôt institutionnel DIAL est destiné au dépôt et à la diffusion de documents scientifiques émanant des membres de l'UCLouvain. Toute utilisation de ce document à des fins lucratives ou commerciales est strictement interdite. L'utilisateur s'engage à respecter les droits d'auteur liés à ce document, principalement le droit à l'intégrité de l'œuvre et le droit à la paternité. La politique complète de copyright est disponible sur la page [Copyright policy](#)

DIAL is an institutional repository for the deposit and dissemination of scientific documents from UCLouvain members. Usage of this document for profit or commercial purposes is strictly prohibited. User agrees to respect copyright about this document, mainly text integrity and source mention. Full content of copyright policy is available at [Copyright policy](#)

Titre: Quasicontinuum analysis of Dislocation-Coherent Twin Boundary interaction to provide local rules to Discrete Dislocation Dynamics.

Auteurs: TRAN, H-S¹
TUMMALA, H.^{2,3}
DUCHENE, L.¹
PARDOEN, T.²
FIVEL, M.³
HABRAKEN, A. M.¹ *anne.habraken@ulg.ac.be*

Source: AIP Conference Proceedings. 2017, Vol. 1896 Issue 1, p1-5. 5p. 2 Diagrams, 1 Graph.

Type de document: Article

Termes de sujet: *COPPER
*KIRKENDALL effect
*DIFFUSION
*DIFFUSION barriers
*SELF-diffusion (Solid state physics)

Code industrie/NAICS: 331420 Copper Rolling, Drawing, Extruding, and Alloying

Résumé: The interaction of a pure screw dislocation with a Coherent Twin Boundary $\Sigma 3$ in copper was studied using the Quasicontinuum method. Coherent Twin Boundary behaves as a strong barrier to dislocation glide and prohibits slip transmission across the boundary. Dislocation pileup modifies the stress field at its intersection with the Grain Boundary (GB). A methodology to estimate the strength of the barrier for a dislocation to slip across CTB is proposed. A screw dislocation approaching the boundary from one side either propagates into the adjacent twin grain by cutting through the twin boundary or is stopped and increases the dislocation pileup amplitude at the GB. Quantitative estimation of the critical stress for transmission was performed using the virial stress computed by Quasicontinuum method. The transmission mechanism and critical stress are in line with the literature. Such information can be used as input for dislocation dynamic simulations for a better modeling of grain boundaries.
[ABSTRACT FROM AUTHOR]

Copyright of AIP Conference Proceedings is the property of American Institute of Physics and its content may not be copied or emailed to multiple sites or posted to a listserv without the copyright holder's express written permission. However, users may print, download, or email articles for individual use. This abstract may be abridged. No warranty is given about the accuracy of the copy. Users should refer to the original published version of the material for the full abstract. (Copyright applies to all Abstracts.)

Affiliations de l'auteur: ¹Dpt ArGEnCo, MS²F- MSM, University of Liège Allée de la Découverte 9, 4000 Liège, Belgium

²Institute of Mechanics, Materials and Civil Engineering (iMMC)-- Université catholique de Louvain, Place Sainte Barbe 2 bte L5.02.02, 1348 Louvain-la-Neuve Belgium

³SIMaP-GPM2 INP Grenoble 101 Rue de la Physique BP46, 38402 St Martin d'Heres cedex France

ISSN: 0094-243X

DOI: 10.1063/1.5008190

Numéro d'accès: 125749275

